

FDL100N50F N-Channel UniFETTM FRFET[®] MOSFET 500 V, 100 A, 55 m Ω

Features

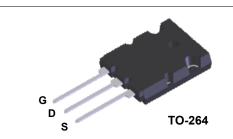
- + $R_{DS(on)}$ = 43 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 50 A
- Low Gate Charge (Typ. 238 nC)
- Low Crss (Typ. 64pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- RoHS Compliant

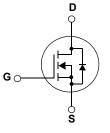
Applications

- Uninterruptible Power Supply
- AC-DC Power Supplypplications

Description

UniFETTM MOSFET is Fairchild Semiconductor[®]'s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. The body diode's reverse recovery performance of UniFET FRFET[®] MOSFET has been enhanced by lifetime control. Its trr is less than 100nsec and the reverse dv/dt immunity is 15V/ns while normal planar MOSFETs have over 200nsec and 4.5V/nsec respectively. Therefore, it can remove additional component and improve system reliability in certain applications in which the performance of MOSFET's body diode is significant. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





TO-264

MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter			FDL100N50F	Unit
V _{DSS}	Drain to Source Voltage			500	V
V _{GSS}	Gate to Source Voltage			±30	V
I _D	Drain Current	- Continuous (T _C = 25 ^o C)		100	^
		- Continuous (T _C = 100 ^o C)		60	— A
I _{DM}	Drain Current	- Pulsed (Note 1)		400	A
E _{AS}	Single Pulsed Avalanche	Energy	(Note 2)	5000	mJ
I _{AR}	Avalanche Current		(Note 1)	100	A
E _{AR}	Repetitive Avalanche Ener	rgy	(Note 1)	73.5	mJ
dv/dt	Peak Diode Recovery dv/c	(Note 3)	20	V/ns	
P _D	Dewer Dissinction	(T _C = 25°C)		2500	W
	Power Dissipation	- Derate above 25°C		20	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

Thermal Characteristics

Symbol	Parameter	FDL100N50F	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.05	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	30	0/00

March 2013

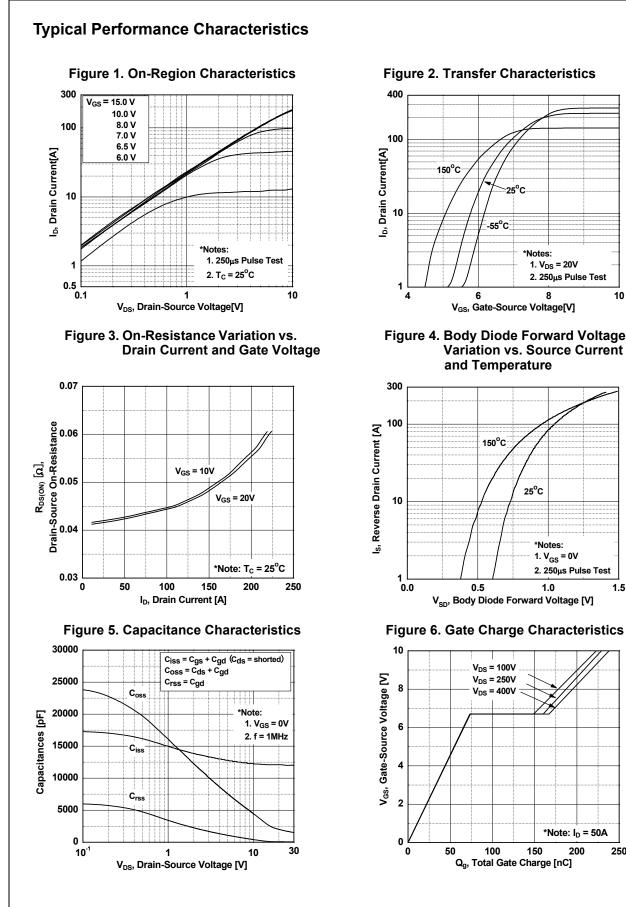
Device MarkingDeviceFDL100N50FFDL100N50F		Device	Package	e F	eel Size	Таре	Width		Quantity	y
				D-264 -		-		30		
Electrica	l Char	acteristics T _c =	25°C unless c	otherwise note	1	1				
Symbol		Parameter			Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristic	S								I
BV _{DSS}	Drain to Source Breakdown Voltage			I _D = 250μA, V _{GS} = 0V, T _C = 25 ^o C			500	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient			$I_D = 250 \mu A$, Referenced to $25^{\circ}C$			-	0.5	-	V/°C
				V _{DS} = 500V, V _{GS} = 0V			-	-	10	
IDSS	Zero Gate Voltage Drain Current		ent	$V_{DS} = 400V, T_{C} = 125^{\circ}C$			-	-	100	μA
I _{GSS}	Gate to Body Leakage Current			$V_{GS} = \pm 30V, V_{DS} = 0V$			-	-	±100	nA
On Charac	teristic	s								
V _{GS(th)}	Gate Threshold Voltage			V _{GS} = V _{DS} , I _D = 250μA			3.0	-	5.0	V
R _{DS(on)}	Static Drain to Source On Resistance			$V_{GS} = 10V, I_D = 50A$			-	0.043	0.055	Ω
9 _{FS}	Forward Transconductance			$V_{DS} = 20V, I_{D} = 50A$			-	95	-	S
C _{iss} C _{oss}	Input Capacitance Output Capacitance			V _{DS} = 25V, V _{GS} = 0V f = 1MHz			-	12000 1700	-	pF pF
C _{rss}	Reverse Transfer Capacitance						-	64	-	pF
Q _{g(tot)}	Total Gate Charge at 10V Gate to Source Gate Charge			$V_{DD} = 400V, I_D = 50A$ $V_{GS} = 10V$		-	238	-	nC	
Q _{gs}						-	74	-	nC	
Q _{gd}	Gate to	Drain "Miller" Charge		(Note 4)			-	95	-	nC
Switching	Charac	teristics								
t _{d(on)}	Turn-Or	Delay Time		V _{DD} = 250V, I _D = 50A			-	63	-	ns
t _r	Turn-Or	Turn-On Rise Time Turn-Off Delay Time		$R_{G} = 4.7\Omega$		F	-	186	-	ns
t _{d(off)}	Turn-Of					-	202	-	ns	
t _f	Turn-Of	f Fall Time		(Note 4)			-	105	-	ns
Drain-Sou	rce Dioo	de Characteristic	S							
I _S	Maximum Continuous Drain to Source Diode Forward Current						-	-	100	Α
I _{SM}	Maximum Pulsed Drain to Source Diode F			Forward Current			-	-	400	Α
V _{SD}	Drain to Source Diode Forward Voltage			V _{GS} = 0V, I _{SD} = 100A			-	-	1.5	V
t _{rr}	Reverse	Recovery Time		V _{GS} = 0V, I _{SD} = 100A dI _F /dt = 100A/μs		-	250	-	ns	
11										

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. L = 1mH, I_{AS} = 100A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

3. I_{SD} \leq 100A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C

4. Essentially Independent of Operating Temperature Typical Characteristics



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Figure 2. Transfer Characteristics

1. V_{DS} = 20V

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*Notes: 1. V_{GS} = 0V

1.0

2. 250µs Pulse Test

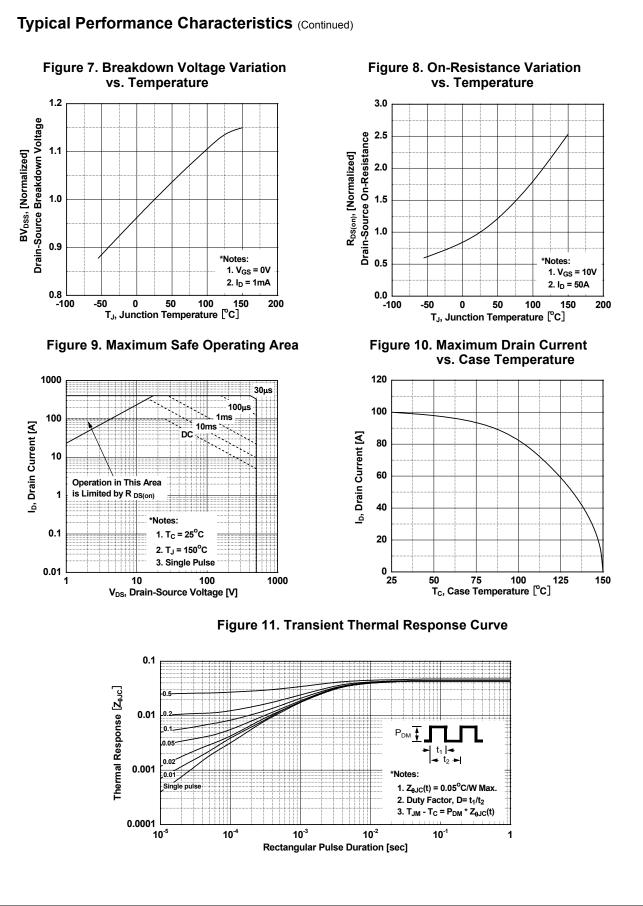
*Note: I_D = 50A

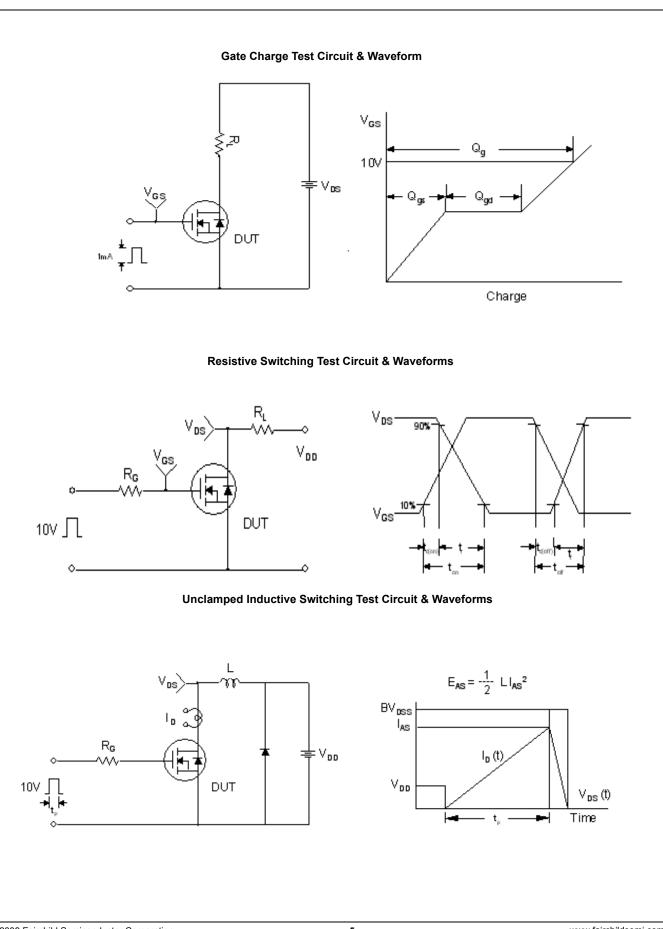
200

1.5

2. 250µs Pulse Test

10

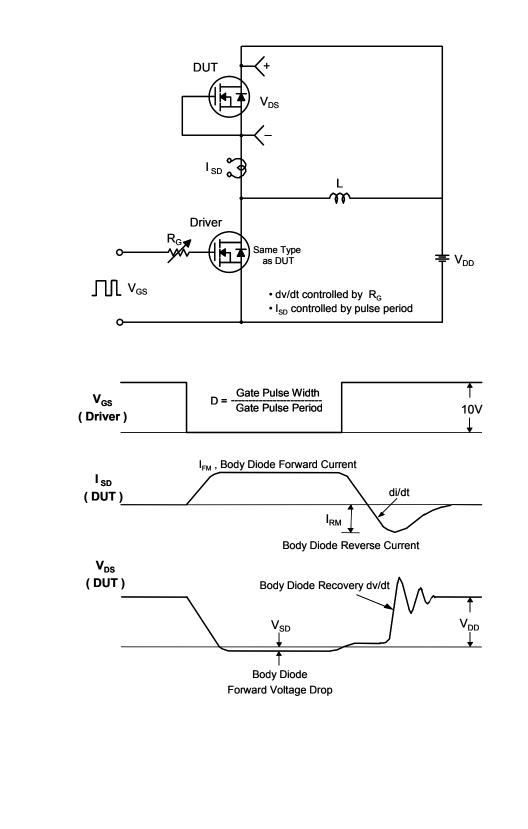


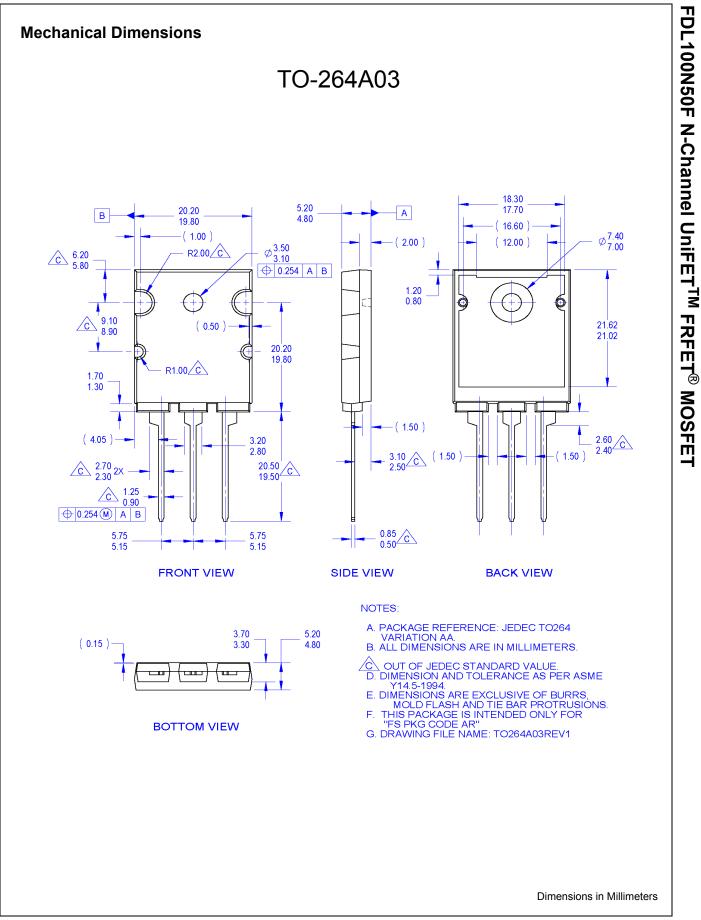


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Peak Diode Recovery dv/dt Test Circuit & Waveforms







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